

Air Purifier preliminary analysis

GOLDTeK_沅聖科技
Roscoe_Huang 黃仁傑
2022/11/18

GOLDTeK Company Profile

COMPANY NAME	GOLDTeK Technology Co., Ltd.
HQ LOCATION	Taiwan 16F, No.166, Jian 1st Rd., Zhonghe Dist., New Taipei City 23511, Taiwan (R.O.C)
FACTORY LOCATION	China Factory: Shenzhen (Foxconn Campus SMT + Assembly) None-China Factory: <ul style="list-style-type: none">- Malaysia (SMT + Assembly)- Taiwan (SMT + Assembly)
ESTABLISH	August, 2008
CAPITAL	USD 10 Million
Foxconn Group	Joined the Group in 2014
IPO	June, 2017
HEAD COUNT	Headquarter: 145person Shenzhen Branch: 1,200 persons
ANNUAL TURNOVER	158M USD (2021)



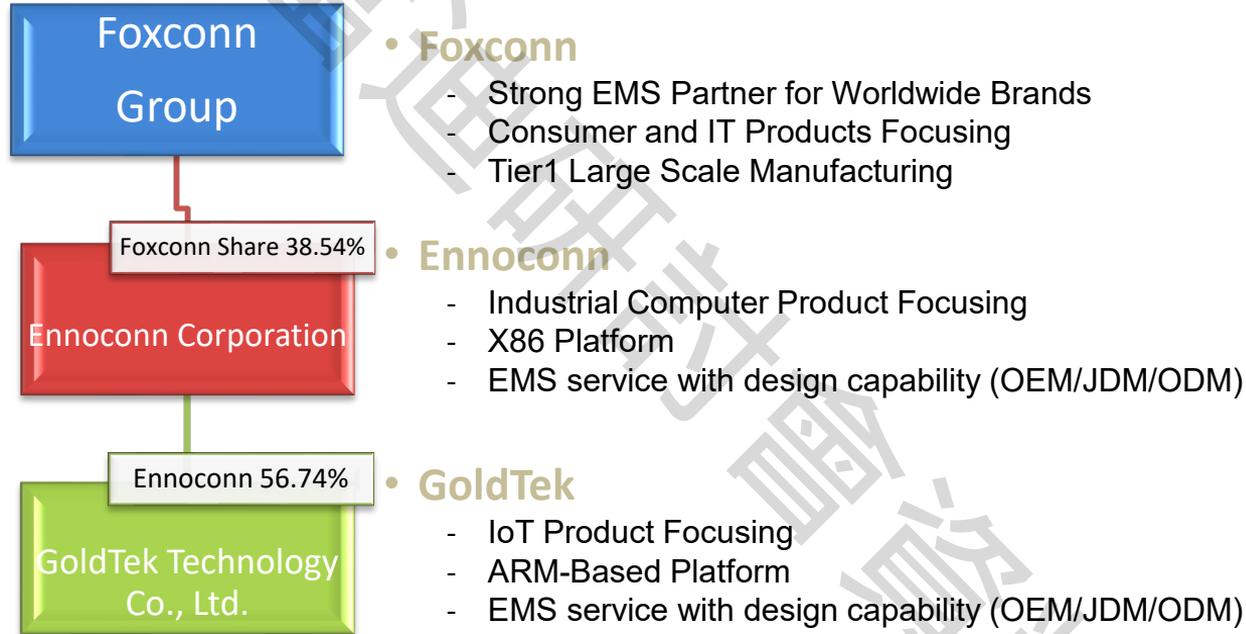
Subsidiary of Foxconn



Expert of Smart Home Products



GOLDTek Ownership Structure & Share



Product Portfolio: Smart Home



Smart Lock



Intercom



Security Camera



DOOR BELL



SMARTHOME



360° Camera

Product Portfolio: Location Finder



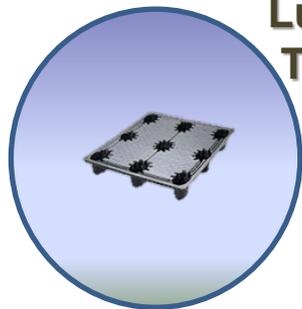
Luggage Tracker



Pet Tracker



BLE Tracker



Pallet Tracker



Health Care

Product Portfolio: Smart Life



Temperature Control



LOGISTIC



Baby Tech



Smart Insole

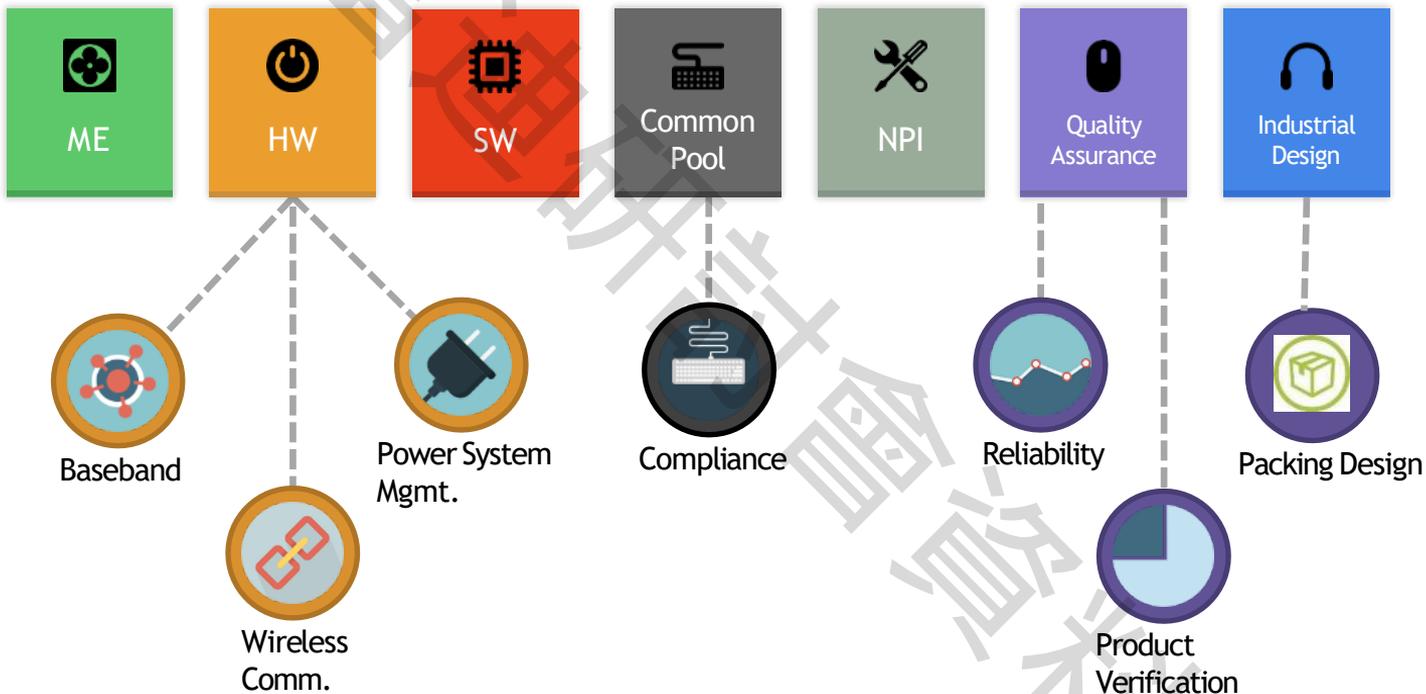


Intelligent

Mailbox

R&D Team

Full Function Engineering Team:
Consisting of more than 100 team members

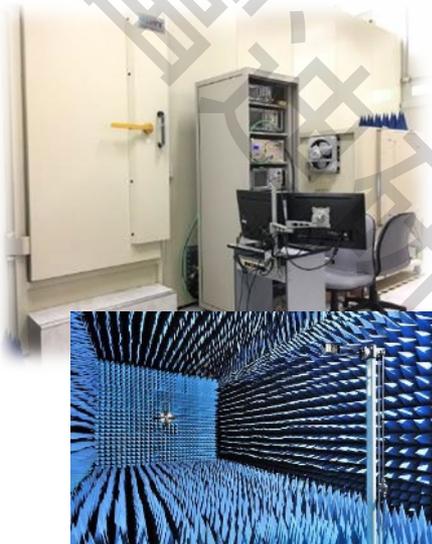


Laboratory

■ Anechoic Chamber



■ OTA Chamber



■ Image Lab

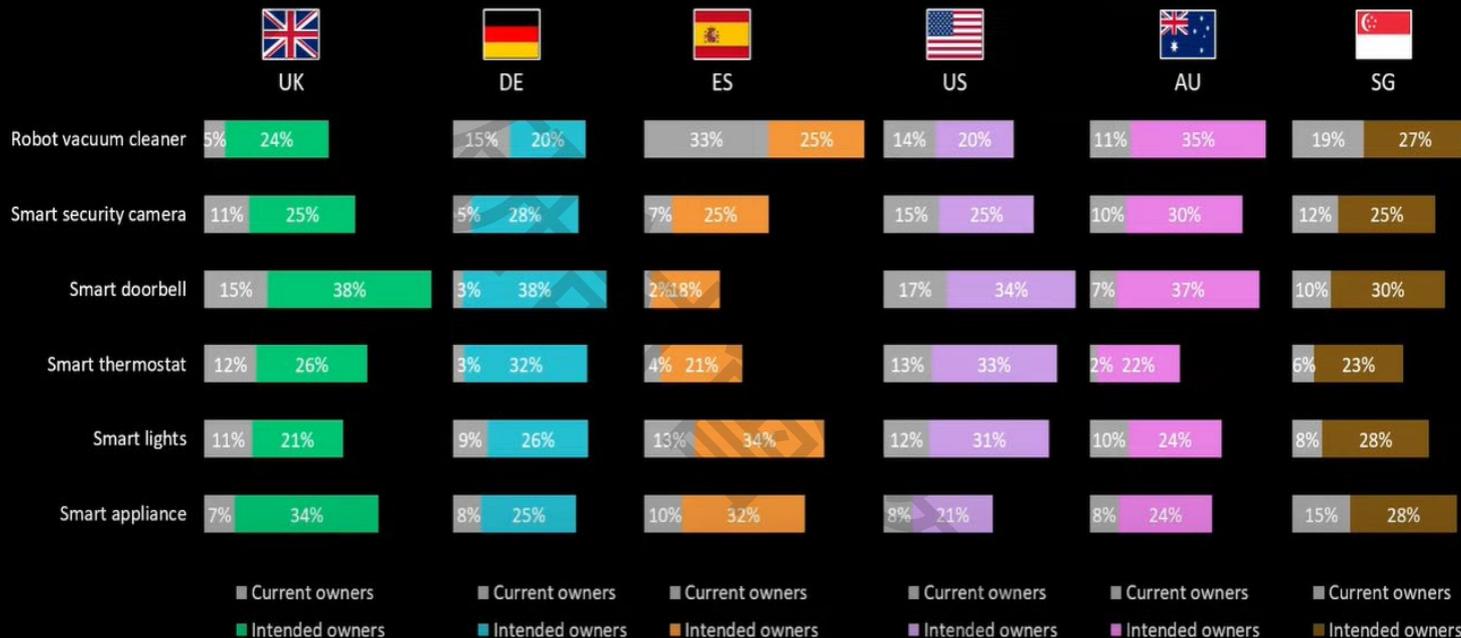


■ Reliability Lab



The Smart Home market Opportunity

Intended ownership of smart home devices, share of all households





Agenda

- **Key Parts disassembly**
- **Fan & Motor information**
- **CFD application**
- **Optimize concept**
- **Wind tunnel information**



Key Parts disassembly



Blade and motor

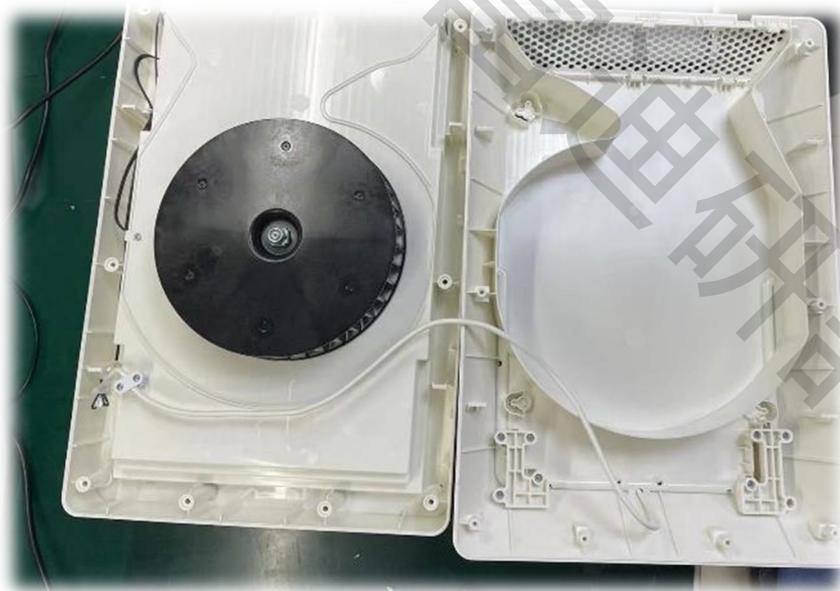


Motor assembly with Chassis



Motor unit

Key Parts disassembly



Chassis-
Front cover

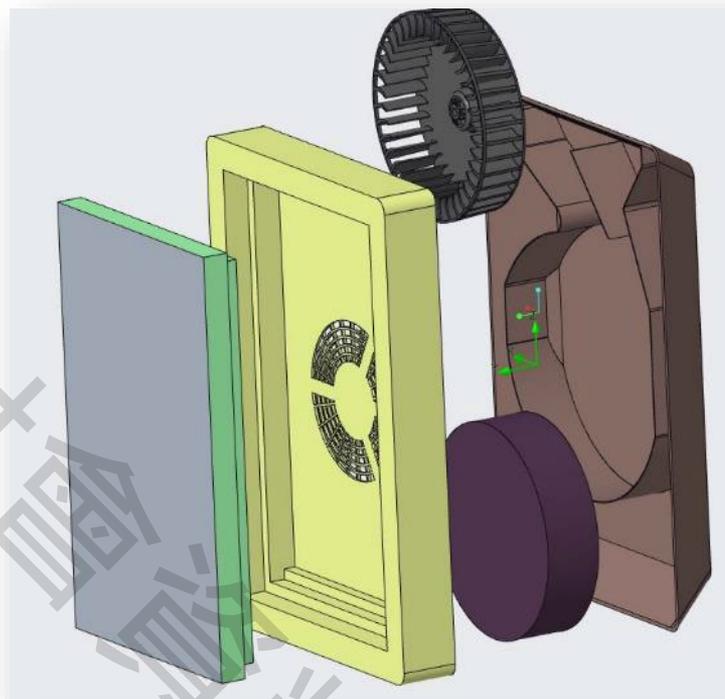
Chassis-
Rear cover



Motor unit

Explosive view & Fan rotation speed

	RPM
Low	387
Medium	882
High	1195



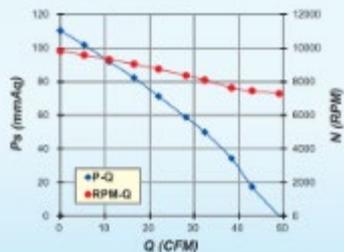
Key parts explosive chart

Wind tunnel

- Based on AMCA 210-07 standard

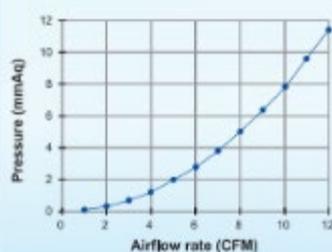
PQ curve

- The fan performance curve with pressure (P) and airflow rate (Q).



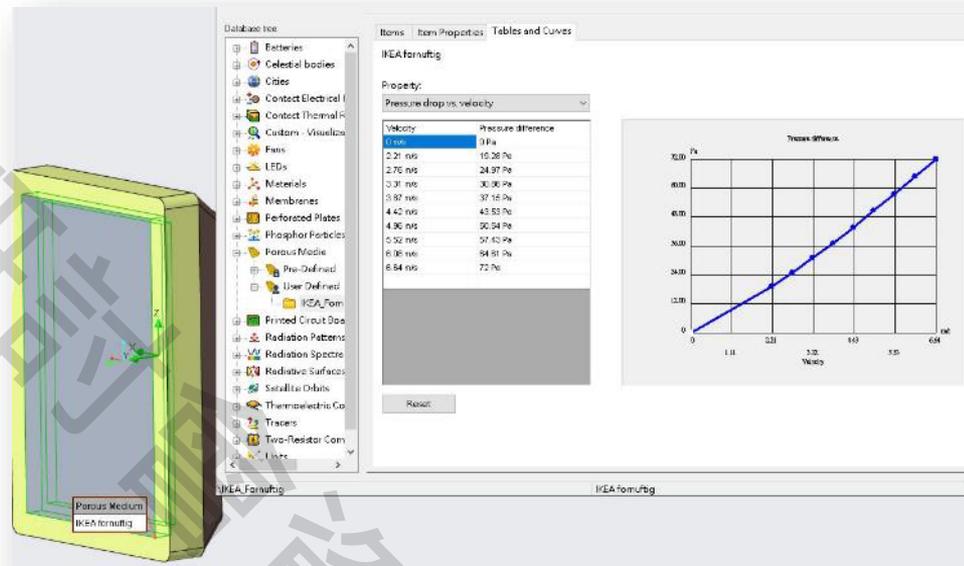
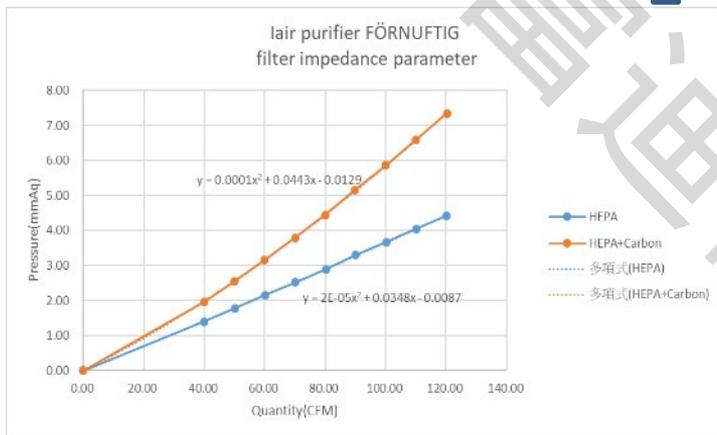
SRC curve

- Applicable to system resistance measurement for PC, Notebook, and server.



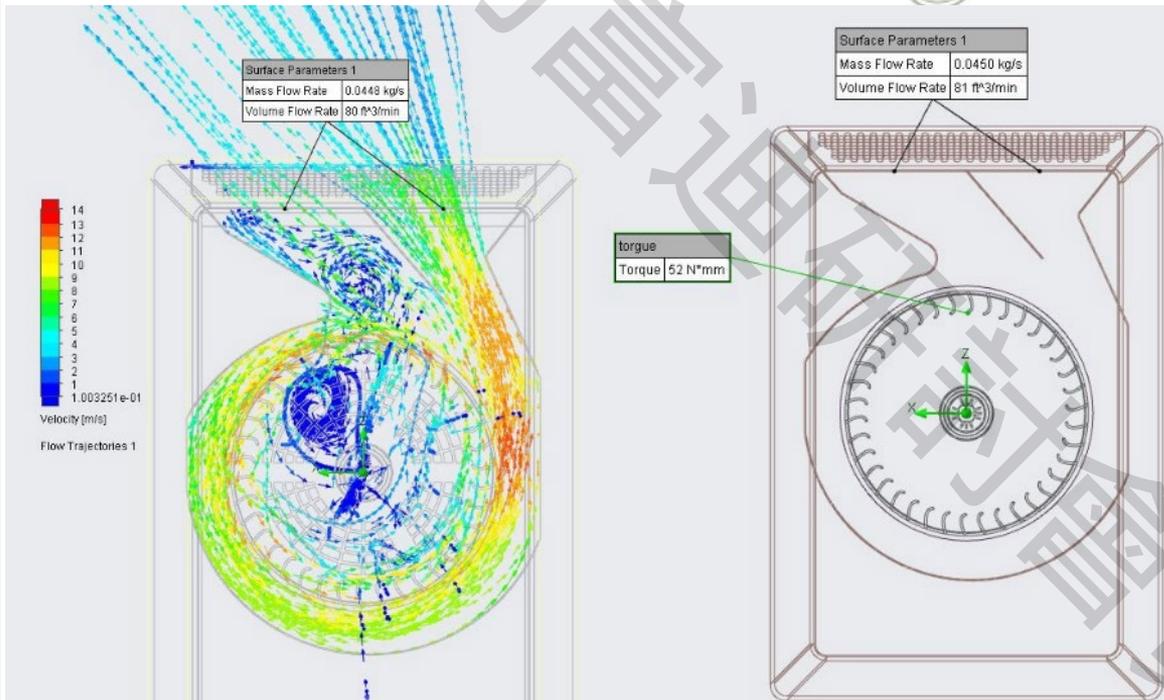
AI智能選擇		
操作 範圍	流量	1-900CFM
	參數	dp: 結構前/後靜壓量測範圍 127mmAq
		PS1: 靜壓量測範圍 25.4mmAq
		PS2: 靜壓量測範圍 101.6mmAq
PS3: 靜壓量測範圍 254mmAq		
設備	設計架構	AMCA 210 Fig.12/ Fig.15
	測試項目	AC Fan PQ, SRC/ DC Fan PQ, SRC
	最大測試物開口	25 * 25 (CM)
	重量	700Kg
電源 系統	設備尺寸	4.0 * 1.0 * 1.7 (M)
	箱體材質	Painted Stainless Steel
控制 系統	輔助風機	AC 220V, 單相, 15A
	控制系統電源	AC 220V, 單相, 10A
輸出格式	控制方式	PC Base/Manual
	輸出格式	HTML/XML/PDF

Wind tunnel parameter transformation



Transfer measurement result to CFD parameter

Flow Dynamics

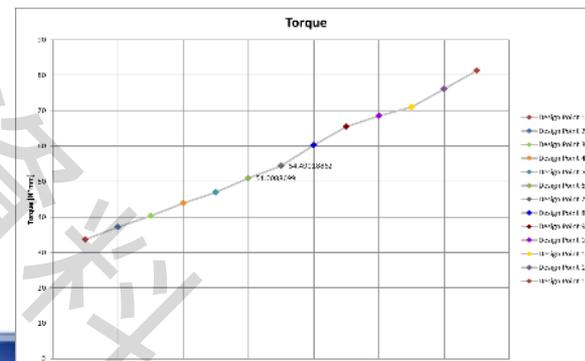


Requirement

120m³/h(Particle, according to GB/T18801-2015)
40m³/h(Formaldehyde, according to GB/T18801-2015)
Tolerance: -10%

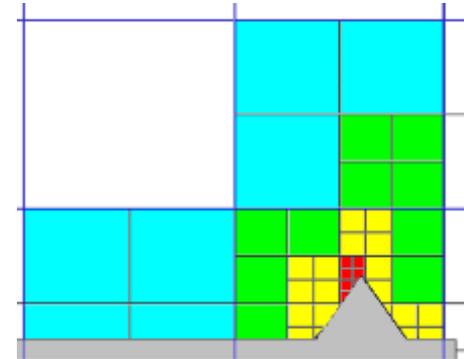
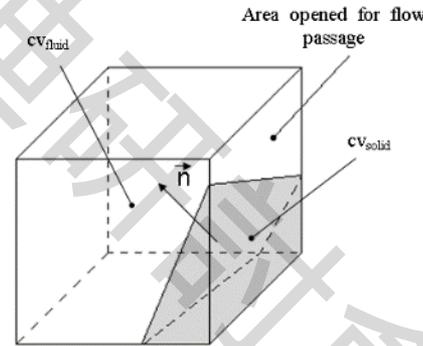
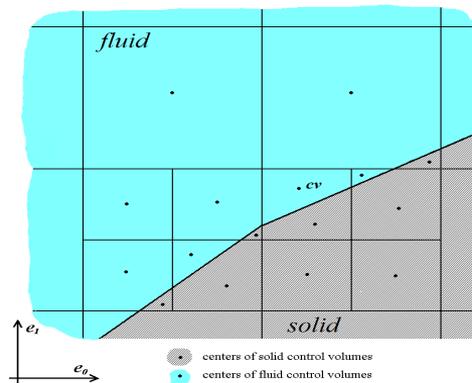
57.3CFM (Smoke according to AHAM)
66.1CFM (Dust according to AHAM)
82.7CFM (Pollen according to AHAM)
Tolerance: -10%

Real blade shape @ 1195 rpm
Out come air flow: 81 CFM
Out come : Torque=52 N*mm



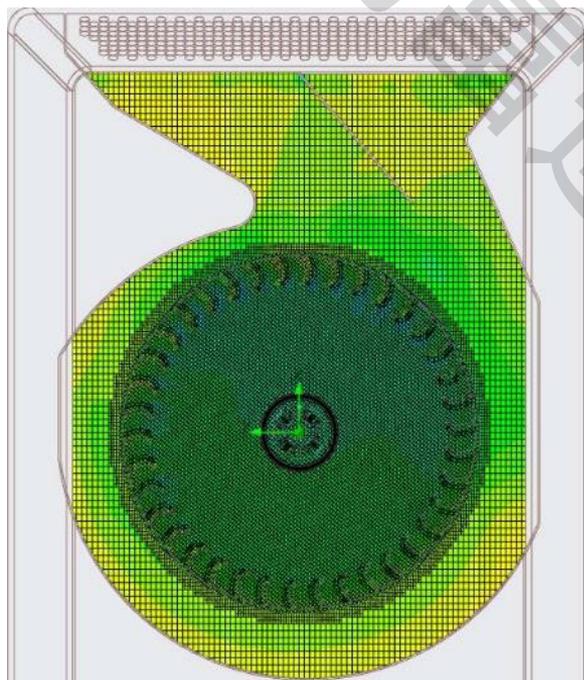
FLOEFD Mesh = Rectangular Polyhedron Hybrid

- Rectangular grid plus polyhedrons near boundaries
- Refinement that splits “parent” parallelepipeds into 8 “daughter” parallelepipeds



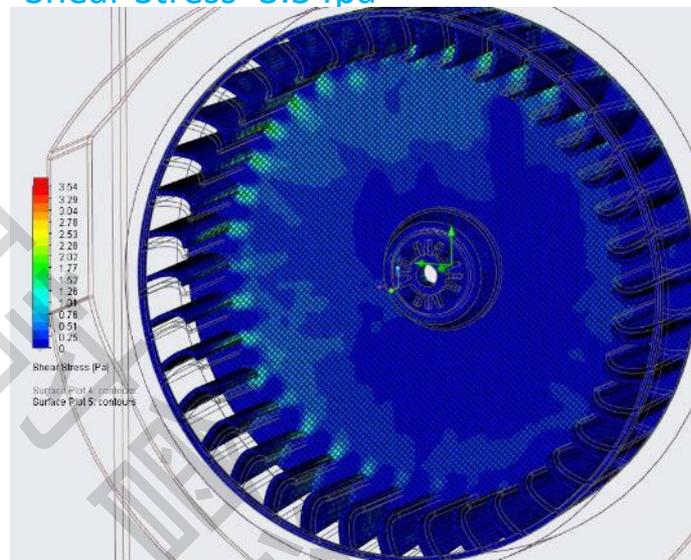
- Polyhedrons near boundary allow treating the geometry in a highly accurate way (surface in cv is presented by sets of connected polygons, and BL uses even its curvature)
- Grid ordering is intensively used for memory and calculation optimizations
- **Octree** refinement facilitates robust and effective multigrid solver technology – one of reason why FLOEFD solver is robust

Flow dynamic

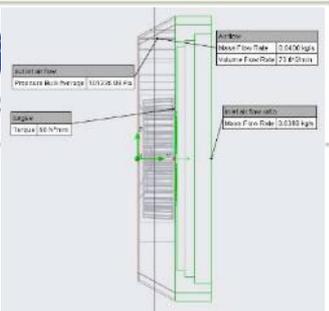
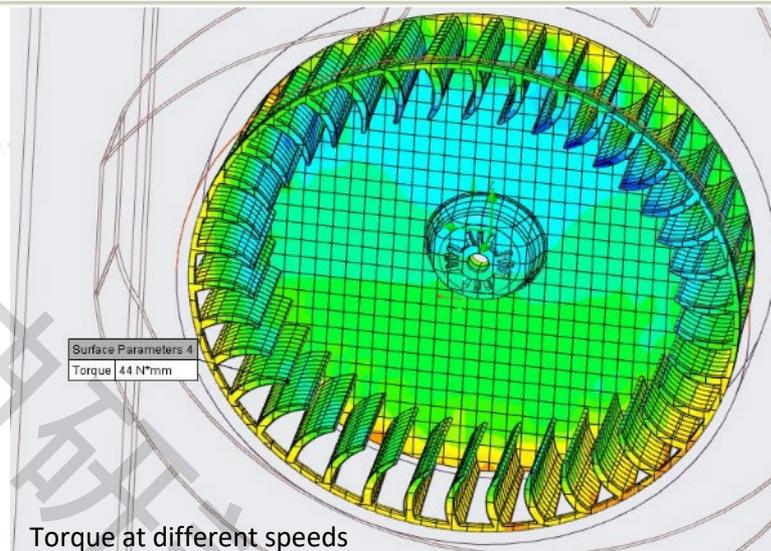
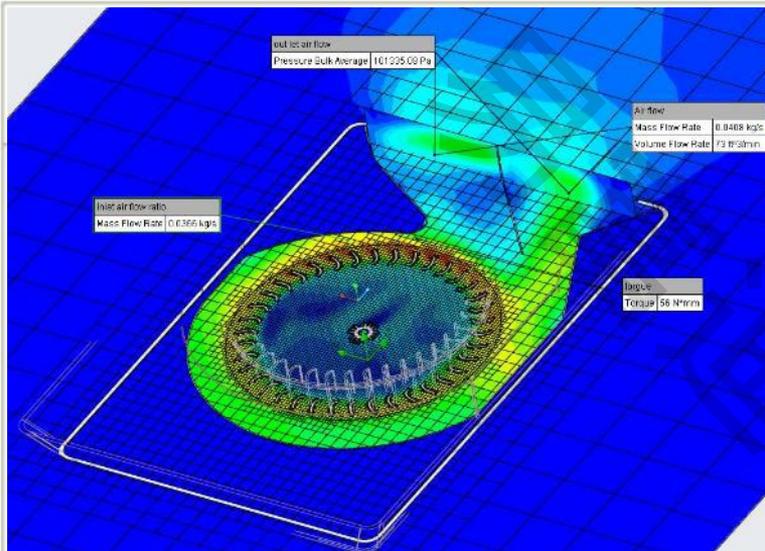


“Partial Cell”
for flow dynamic analysis

Using Flow dynamic analysis can take
Shear Stress=3.54pa



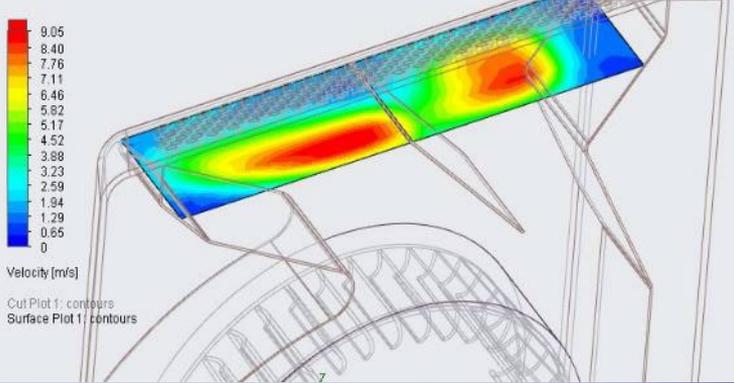
流體運動時，因流向橫斷面(cross section)上有流速的差異而發生的剪力效應，以單位面積所受的剪力表現之，稱為**剪應力**。剪應力之發生，有因流體分子黏性而存在者，稱為**黏性剪應力**，表為 $\tau_l = \mu \, du/dy$ ；有因亂流之擾動，產生橫斷面上有流向的動量的傳輸而表現出來的剪力效應，稱亂流雷諾茲應力(turbulent Reynolds shear stress)



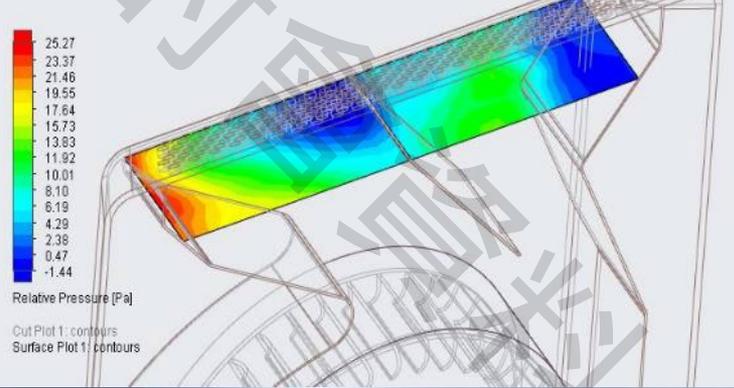
Section view

Torque at different speeds

Outlet velocity distribution

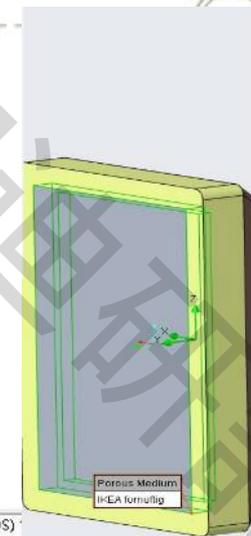
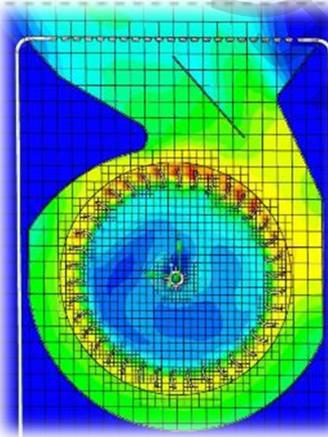


Air outlet pressure distribution



Obtain a variety of numerical parameters

Powerful database & Heeds optimize function



Database tree

- Batteries
- Celestial bodies
- Cities
- Contact Electrical I
- Contact Thermal R
- Custom - Visualize
- Fans
- LEDs
- Materials
- Membranes
- Perforated Plates
- Phosphor Particles
- Porous Media
- Pre-Defined
- User Defined
- IKEA_Horn
- Printed Circuit Boa
- Radiation Patterns
- Radiation Spectra
- Radiative Surfaces
- Satellite Orbits
- Thermoelectric Co
- Tracers
- Two-Resistor Cam
- Units

Items: Item Properties Tables and Curves

IKEA formuftig

Property: Pressure drop vs. velocity

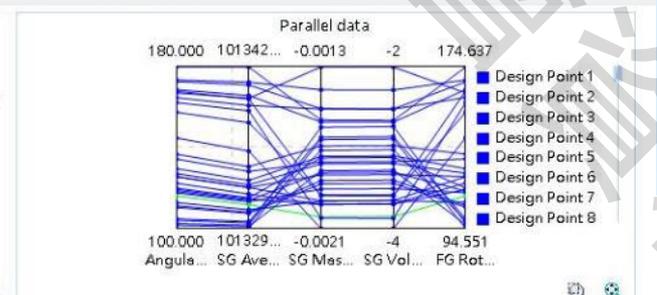
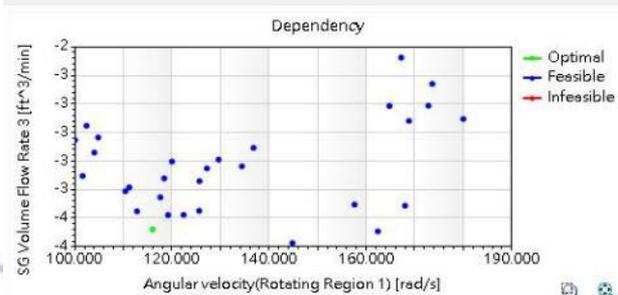
Velocity	Pressure difference
2.21 m/s	19.20 Pa
2.76 m/s	24.07 Pa
3.31 m/s	30.86 Pa
3.87 m/s	37.15 Pa
4.42 m/s	43.53 Pa
4.98 m/s	50.54 Pa
5.52 m/s	57.43 Pa
6.03 m/s	64.61 Pa
6.64 m/s	72 Pa

Reset

Multiparameter Optimization (HEEDS) 1

Multiparameter Optimization (HEEDS) ▾

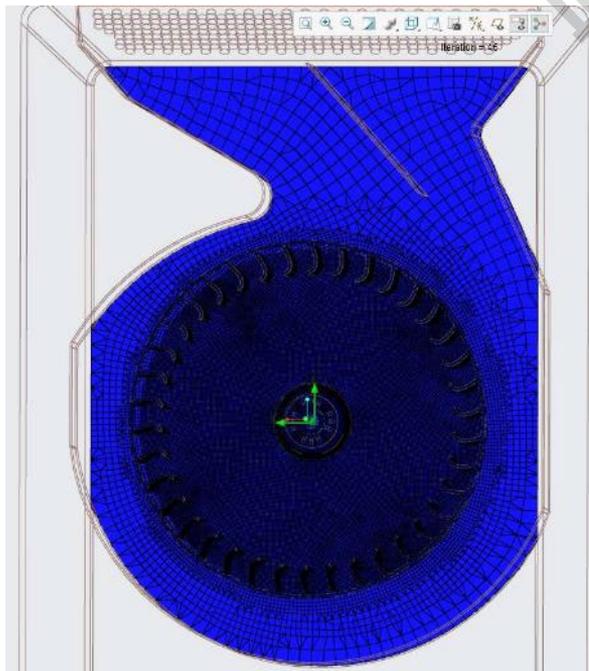
Input Variables Output Parameters Scenario Study Plots Results Summary Goals Mesh 1 Cut Plot 1 Cut Plot 2 Surface Plot 1 Flow



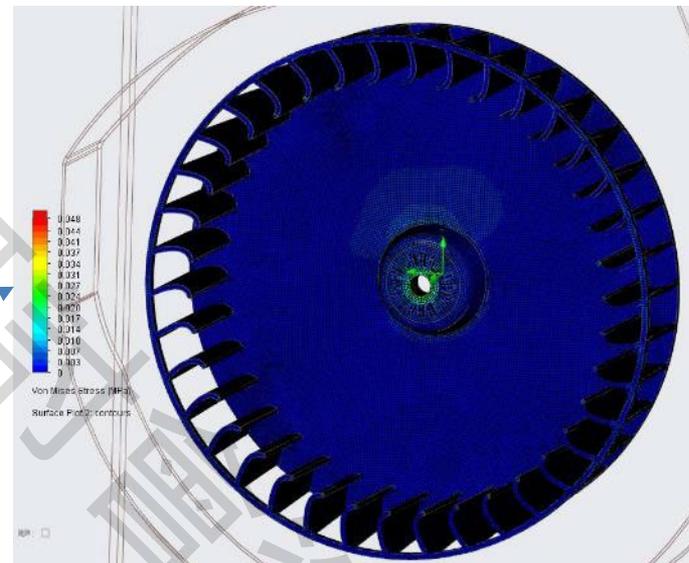
Using Heeds Optimized CFD module to find the accurate speed (RPM) and air output (CFM) of Air purifier

Structural mechanics

“Hexahedral mesh”
for structure analysis

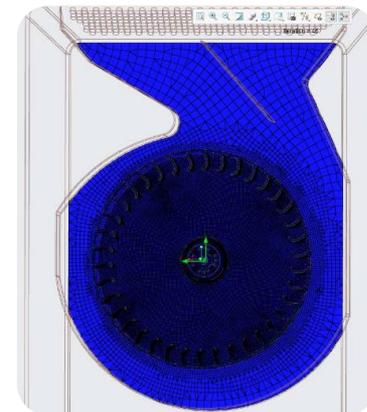
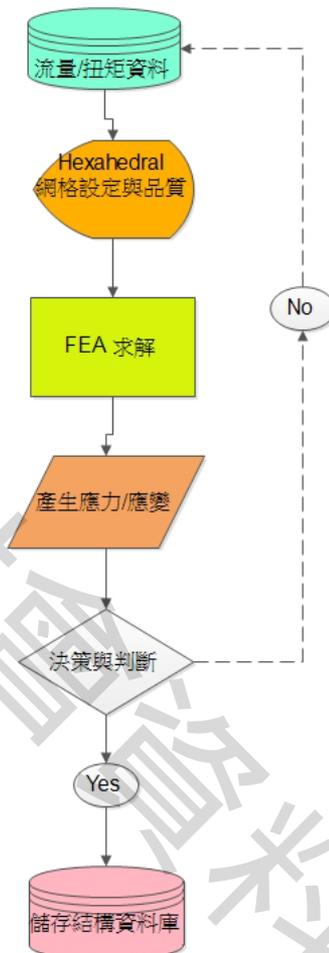
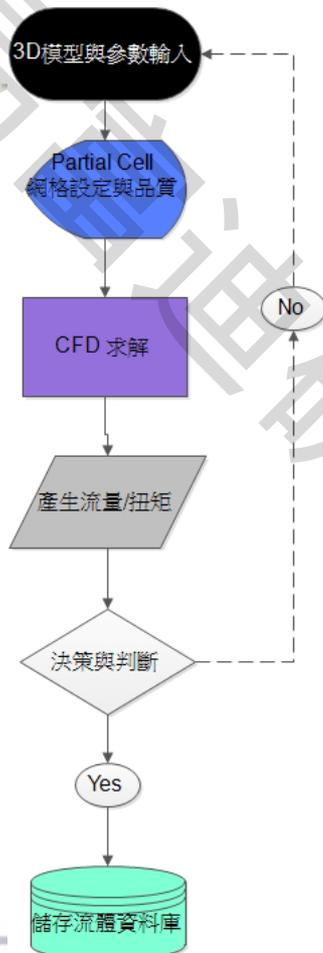
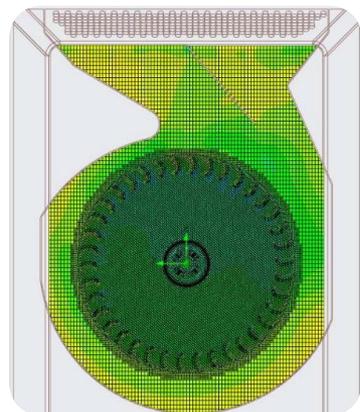


Stress concentration distribution area



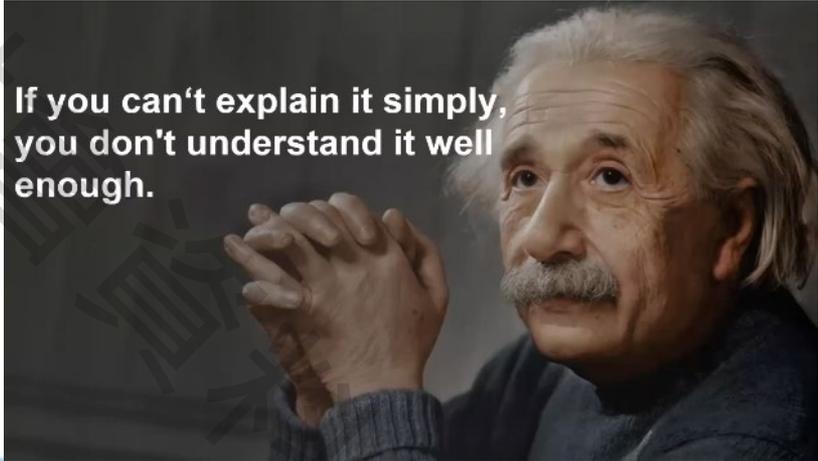
1. Torque = 52 N*mm & 81 CFM is derived from the **actual shape of the blade through Flow analysis.**
2. Using **Stress analysis** for Blade's Von Mises Stress=0.048Mpa

Analysis Process



- **FloEFD can provide unlimited possibilities for product planning, enhance the impression of customer proposals, design quality and risk assessment capabilities**
- **Good software providers can only accelerate the learning curve of the software, but the choice of quality suppliers with technical depth can accelerate the commercialization of products.**

FloEFD™
for
PTC CREO



If you can't explain it simply,
you don't understand it well
enough.



Layers

- top
- 地線體
- l2_gnd
- 地線體_1
- l3_vcc
- 地線體_2
- bottom

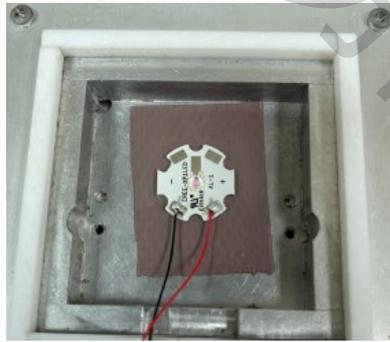
Components

Active Components

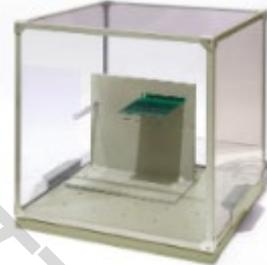
J1 [FPC-34P-19_0X3]	0 W
LED19 [LED-3_7X3_]	0 W
LED20 [LED-3_7X3_]	0 W
LED21 [LED-3_7X3_]	0 W
LED22 [LED-3_7X3_]	0 W
LED23 [LED-3_7X3_]	0 W
LED24 [LED-3_7X3_]	0 W
PAD1 [DOME5_0M]	0 W
PAD2 [DOME5_0M]	0 W
PAD3 [DOME5_0M]	0 W
PAD4 [DOME5_0M]	0 W



T3Ster (Thermal Transient Tester) - 暫態熱阻量測系統



T3Ster Master structure function(x)



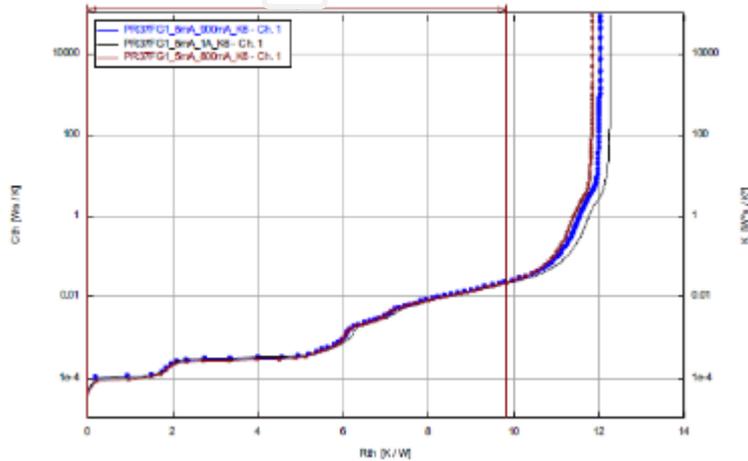
JEDEC 自然對流腔體

應用範圍包括：

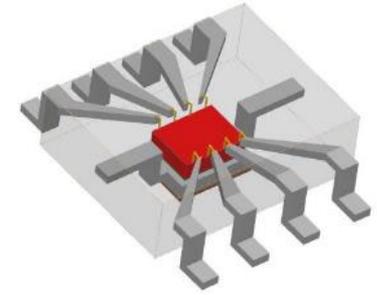
- 重建的熱流路徑
- 晶粒安裝品質
- 堆疊晶片封裝
- Power LED 特性
- 確定材料屬性
- 驗證熱模型
- 現場非破壞性故障分析
- 通過迴圈提供功率和結構函數分析，進行可靠性測試
- 應用環境中對現有系統內器件的熱測試



PELNUS 溫度控制裝置

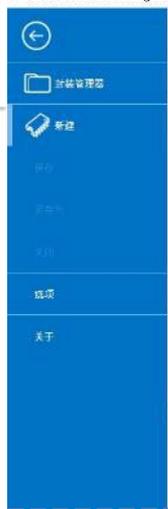


- Integral Structure Function@ 25 °C
- Use TDI Method (different Thermal PAD) , JESD 51-14
- Rthjc = ??? C/W



Items	Item Properties	Tables and Curves	Value
Property Name			Battery with real coefficients (Y)
Comments			For Testing
Density			2750 kg/m ³
Specific heat			823 J/(kg*K)
Conductivity type			Orthotropic
Thermal conductivity in X			28.05 W/(m*K)
Thermal conductivity in Y			3.4 W/(m*K)
Thermal conductivity in Z			28.05 W/(m*K)
Electrical conductivity in X			Conductor
Resistivity in X			7e-08 Ohm*m
Electrical conductivity in Y			Conductor
Resistivity in Y			7e-08 Ohm*m
Electrical conductivity in Z			Conductor
Resistivity in Z			7e-08 Ohm*m
Radiation properties			<input type="checkbox"/>
Sorption properties			<input type="checkbox"/>
Melting temperature			<input checked="" type="checkbox"/> 1728.15 K
Temperature			<input type="checkbox"/>
Elastic properties			<input type="checkbox"/>

FLOEFD Package Creator

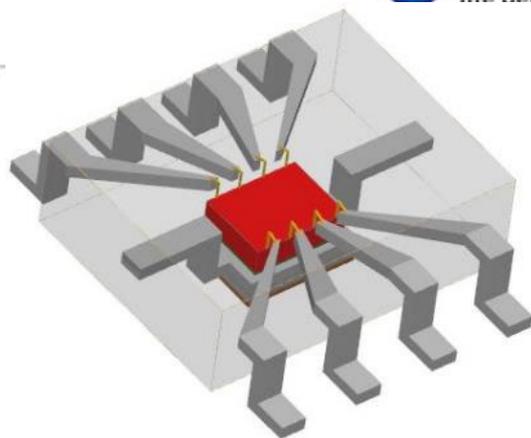


新建封装 选择起始模板

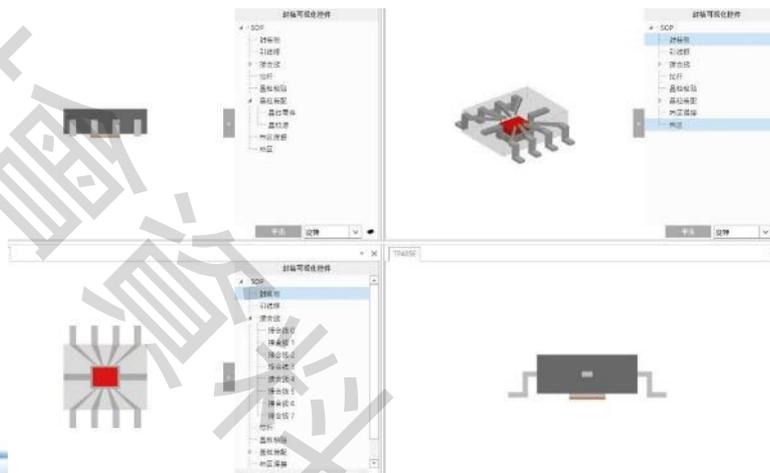


选择模板

全部



设计名称	SOP-8		✓
外形类型	标准外形		✓
Jedec 覆晶范围	3.81x4.93mm		✓
Jedec 引线	8		✓
热功率	1.4100	W	✓
晶粒长度	1.4790	mm	✓
晶粒宽度	1.1430	mm	✓
外覆焊盘	<input checked="" type="checkbox"/>		✓
引线框材料	高于合金 42		✓





Thank You!!